V8PM15

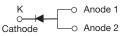
Vishay General Semiconductor

High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.58$ V at $I_F = 4$ A



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PRIMARY CHARACTERISTICS				
I _{F(AV)}	8.0 A			
V _{RRM}	150 V			
I _{FSM}	140 A			
V_F at I_F = 8.0 A (T_A = 125 °C)	0.66 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.1 mm
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 gualified available - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 halogen-free, RoHS-compliant, and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PM15	UNIT	
Device marking code		8M15		
Maximum repetitive peak reverse voltage	V _{RRM}	150	V	
Maximum average forward restified surrent (fig. 1)	I _F ⁽¹⁾	8.0	Α	
Maximum average forward rectified current (fig. 1)	I _F ⁽²⁾	3.2		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	140	A	
perating junction temperature range T _J ⁽³⁾		-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended copper pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_{.1} <1/ R_{0.1A}

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.75	-	v
	I _F = 8.0 A			1.00	1.08	
	I _F = 4.0 A	T _A = 125 °C		0.58	-	
	I _F = 8.0 A			0.66	0.72	
Reverse current	V _B = 100 V	T _A = 25 °C	I _R ⁽²⁾	0.001	-	- mA
	$v_{\rm R} = 100 v$ $T_{\rm A} =$	T _A = 125 °C		1.5	-	
Reverse current	V _B = 150 V	T _A = 25 °C	I _R ⁽²⁾	-	0.15	mA
	V _R = 150 V T,	T _A = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MHz		CJ	460	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PM15	UNIT	
Tunical thormal registeres	R _{0JA} ⁽¹⁾⁽²⁾	75	°C/W	
Typical thermal resistance	R _{0JM} ⁽³⁾	4		

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

⁽²⁾ Free air mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient ⁽³⁾ Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PM15-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V8PM15-M3/I	0.10	I	6500	13" diameter plastic tape and reel	
V8PM15HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel	
V8PM15HM3/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

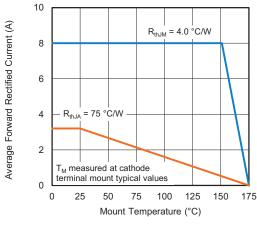


Fig. 1 - Forward Current Derating Curve

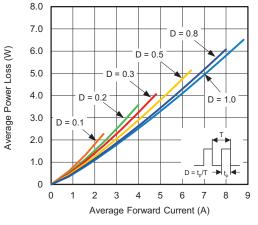


Fig. 2 - Forward Power Loss Characteristics

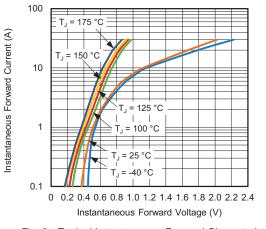


Fig. 3 - Typical Instantaneous Forward Characteristics

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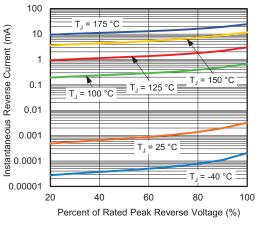


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

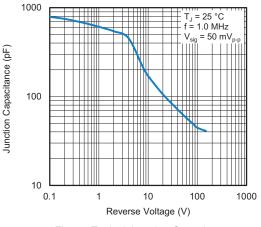
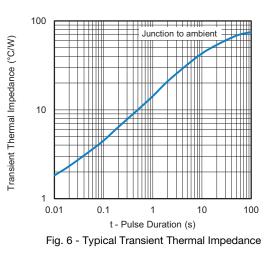
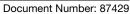


Fig. 5 - Typical Junction Capacitance



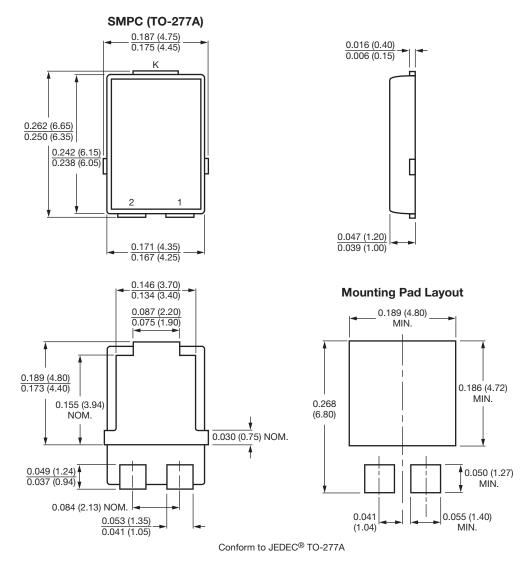


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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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